ABBOCIATION CONNECTING ELECTRONICS INDUSTRIES® International and Pa	IPC, Bannock	burn, Illinois. A	All rights reserved u ntions.	nder both	This docume level parts, t	ent is a declar the declaration	ration of n encon	f the substance npasses all low	es within ver level	the manufact materials for	urer listed i which the n	tem. N nanufao	ote: if the	e item is an as s engineering	sembly with low responsibility.	
	IPC Web Site for Information on IPC-1752 Standard Form Ty http://www.ipc.org/IPC-175x Distribut				*	Declaration Class * Class 6 - RoHS Yes/No, Homogeneous Mater					erials and M	ials and Mfg Information				
Supplier Information																
Company name* Company			pany unique ID U			Unique ID Authority					Respons	Response Date*				
nsemi											2023-06-08					
Contact Name Title - Contact				P			Phone - Contact*					Email - Contact*				
Product-Env-Stewards	Product Envi	Product Enviro Compliance			NA					Produc	Product-Env-Stewards@onsemi.com					
Authorized Representative* Tit			Title - Representative			Phone - Representative*				Email -	Email - Representative*					
Product-Env-Stewards	Product Enviro Compliance				NA				Produc	Product-Env-Stewards@onsemi.com						
Requester Item Number	Mfr Iten	n Number				Effective Da	ate Ve	ersion	n Manufacturing Site		,	Weight	t*	UOM	Unit Type	
	LC717A	00AR-NH				2023-06-08			PHM	РНМ		20.0		mg	Each	
Ianufacturing Proccess Informa	ntion					- -	1								1	
Terminal Plating / Grid Array M	laterial [	Ferminal Base	Alloy J	J-STD-020 MSL Rating		Peak Process		s Body Temperature Max Time at Peal		ık Temperat	Temperature Number		of Reflow Cyc	les		
Precious metal (e.g. Ag,Au, NiPdAu) (no Sn)		CU Alloy 3		3		260		C	30	30		ds 3	3			
comments																
TTENTION: MSL 3 Rated item requir	es Bake and I	Dry Pack (after	r electrical test)													
or more information regarding materia	l composition	please refer to	page 3													

RoHS Material Composition Declaration				Declaration Type *	Detailed						
Directive 2015/863/EU amending RoHS Directive 2011/65/EU	RoHS Definition: Quantity limit of 0.01% by mass (100 PPM) in homogeneous material for Cadmium and quantity limit of 0.1% by mass (1000 PPM) in homogeneous material for: Lead (Pb), Mercury (Hg), Hexavalent Chromium (Cr6+), Polybrominated Biphenyls (PBB), Polybrominated Diphenyl Ethers (PBDE), and Bis(2-ethylhexyl) phthalate (DEHP), Benzyl-butyl ohthalate (BBP), Dibutyl phthalate (DBP), Disobutyl phthalate (DIBP).										
cadmium, hexavalentchromium, polybrominate contains a RoHS restricted substance inexcess encompass all such components. Supplier certif as of the date that Supplier completes this form Company acknowledges that Supplier may hav independently verified information provided by certification in this paragraph. If the Company a	ed biphenyls and/or polybrominated dip of an applicable quantity limit, please ir ies that it gathered the information it pro- .Supplier acknowledges that Company e relied on informationprovided by othe y others, Supplier agrees that, at a minin and the Supplier enter into a written agre pource of the Supplier's liability and the	henyl ethers (each a " ndicate below which, i ovides in this form us will rely on this certifiers in completing this num, itssuppliers have eement with respect to Company's remedies	RoHS restricted substance") in exce if any, RoHS exemption you believe ing appropriate methods to ensure if ication in determining the complian form, and that Supplier may not have e provided certifications regarding the to the identified part, the terms and cc for issues that arise regarding inform	ce of its products with European Union membe	ove. If a homogeneous material within the part er level components, the declaration shall l correct to the best of its knowledge and belief, r state laws that implement the RoHS Directive. wever, in situations where Supplier has not tions are at least as comprehensive as the anty rights and/or remedies provided as part of						
RoHS Declaration * 1 - Item(s)	does not contain RoHS restricted substa	ances per the definitio	on above	Supplier Acceptance	* Accepted						
Exemption: If the declared item does not con applicable exemptions.	ntain RoHS restricted substances per	the definition above	except for defined RoHS exempti	ons, then select the corresponding response i	n the RoHS Declaration above and choose all						
Exemption List Version	EL-2011/534/EU										
Declaration Signature											
Instructions: Complete all of the required fin Requester) and click on Submit Form to have	elds on all pages of this form. Select the form returned to the Requester	he "Accepted" on th	e Supplier Acceptance drop-down	. This will display the signature area. Digital	lly sign the declaration (if required by the						
Supplier Digital Signature Ra	stislav Drska	Le									

## Homogeneous Material Composition Declaration for Electronic Products

SubItem Instructions: The presence of any JIG Level A or B substances must be declared. [1] indicate the subpart in which the substance is located, [2] provide a description of the homogeneous material [3], enter the weight of the homogeneous material.

Homogeneous Material	Weight	Unit of Measure	Level	Substance	CAS	Exempt	Weight	Unit of Measure
Die	1.44	mg	Supplier	Silicon (Si)	7440-21-3		1.4308	mg
			Supplier	Polyimide	Proprietary Data		0.0092	mg
Die Attach 0.06	0.06	mg	Supplier	Epoxy resins	129915-35-1		0.0435	mg
			Supplier	Acrylic resins	Proprietary Data		0.0165	mg
Mold Compound-Black 13.87	13.87	mg		Epoxy Phenol Resin	proprietary data		1.5257	mg
			Supplier	Carbon Black (C)	1333-86-4		0.0277	mg
			Supplier	Fused Silica (SiO2)	60676-86-0		11.7618	mg
			Supplier	Silica Crystalline (SiO2)	14808-60-7		0.5548	mg
Substrate and Solder Mask 4	4.4	mg	В	Nickel (Ni)	7440-02-0		0.3164	mg
			Supplier	Gold (Au)	7440-57-5		0.0682	mg
			Supplier	Bismaleimide Triazine resin	Proprietary Data		2.6893	mg
			Supplier	Copper (Cu)	7440-50-8		1.3262	mg
Wire Bond - Au	0.23	mg	Supplier	Gold (Au)	7440-57-5		0.23	mg